### PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5731940

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
RUILONG XIE	09/23/2019
KANGGUO CHENG	09/23/2019
CHANRO PARK	09/23/2019
JUNTAO LI	09/23/2019

### **RECEIVING PARTY DATA**

Name:	INTERNATIONAL BUSINESS MACHINES CORPORATION
Street Address:	NEW ORCHARD ROAD
City:	ARMONK
State/Country:	NEW YORK
Postal Code:	10504

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16578749

### CORRESPONDENCE DATA

**Fax Number:** (561)989-9812

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 561-989-9811

**Email:** ptoboca@fggbb.com

Correspondent Name: FLEIT GIBBONS GUTMAN BONGINI & BIANCO PL

**Address Line 1:** 4800 N. FEDERAL HIGHWAY, SUITE B306

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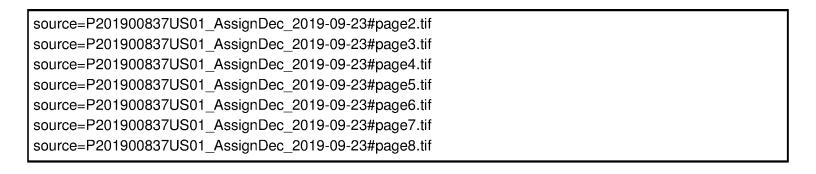
ATTORNEY DOCKET NUMBER:	P201900837US01
NAME OF SUBMITTER:	JOSE GUTMAN
SIGNATURE:	/Jose Gutman/
DATE SIGNED:	09/23/2019
	This document serves as an Oath/Declaration (37 CFR 1.63).

**Total Attachments: 8** 

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PATENT REEL: 050458 FRAME: 0868

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PATENT REEL: 050458 FRAME: 0869

# DECLARATION (37 C.F.R. 1.63) FOR UTILITY PATENT APPLICATION USING AN APPLICATION DATA SHEET (37 C.F.R. 1.76) AND ASSIGNMENT

Title of Invention: METHOD AND STRUCTURE TO IMPROVE OVERLAY MARGIN OF NON-SELF-ALIGNED CONTACT IN METALLIZATION LAYER

· · · · · · · · · · · · · · · · · · ·
As a below named inventor, I hereby declare that:
This declaration is directed to the attached application, or (if following box is checked):
☐ United States application or PCT international application numberfiled on
The above-identified application was made or authorized to be made by me.
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.
I have reviewed and understand the contents of the application, including the claims.
I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR Section 1.56.
Whereas, the undersigned inventor(s) has/have made certain inventions, improvements, and discoveries (herein referred to as the "invention") disclosed in the above-identified patent application and further identified by the IBM Docket Number provided above in the header of this document;
Whereas, International Business Machines Corporation, a corporation of New York having a place of business at Armonk, New York (herein referred to as "IBM"), desires to acquire, and each undersigned inventor desires to grant to IBM, the entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned inventor ("ASSIGNOR") hereby sells or has sold, assigns or has assigned, and otherwise transfers or has transferred to IBM (the "ASSIGNEE"), its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions. continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, each undersigned inventor hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the invention, to IBM, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by IBM, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in IBM, its successors, legal representatives, and assigns, whenever requested by IBM, its successors, legal representatives, or assigns.

Each undersigned inventor acknowledges their prior and ongoing obligations to sell, assign, and transfer the rights under this Assignment to IBM and is unaware of any reason why they may not have the full and unencumbered right to sell, assign, and transfer the rights hereby sold, assigned, and transferred, and has not executed, and will not execute, any document or instrument in conflict herewith. Each undersigned inventor also hereby grants IBM, its successors, legal representatives, and assigns, the right to insert in this Assignment

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I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

(1) Legal Name of Inventor: RUILONG XIE	
Signature:	Date: 9/23/20
(2) Legal Name of Inventor: Kangguo CHENG	
Signature:	Date:
(3) Legal Name of inventor: Chanro PARK	
Signature:	Date:
(4) Legal Name of Inventor: Juntao LI	
Signature:	Date

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United States application or PCT international application number filed on
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(1) Legal Name of Inventor: <b>RUILONG XIE</b>	
Signature:	Date:
(2) Legal Name of Inventor: Kangguo CHENG	
Signature:	9/23/2019 Date:
(3) Legal Name of Inventor: Chanro PARK	
Signature:	Date:
(4) Legal Name of Inventor: <b>Juntao Li</b>	
Signature:	Date:

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			A		
☐ United Stat	es application or PC1	international applicat	tion number	filed on	*
The above-ide	ntified application wa	s made or authorized	to be made by me.		
I believe that I	am the original inven	tor or an original joint	inventor of a claimed in	vention in the applicati	on.
I have reviewe	d and understand the	contents of the applic	cation, including the clai	ims.	
I am aware of to be material	he duty to disclose to o patentability as del	o the United States Pa ined in 37 CFR Section	itent and Trademark Of on 1.56.	fice all information kno	wn to me
referred to as	the "Invention") discl	(s) has/have made cer osed in the above-ide a in the header of this	rtain inventions, improve entified patent applicati document;	ements, and discoverie on and further identifie	s (hereined by the
at Armonk, Ne grant to IBM, the	w York (herein referre	ed to as "IBM"), desire ght, title, and interest	a corporation of New Yes to acquire, and each in and to the Invention	undersigned inventor of	lesires to

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Signature:	Date:
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Signature:	Date:
(3) Legal Name of Inventor: Chanro PARK Signature:	Date: 9/23/2019
(4) Legal Name of Inventor: <b>Juntao LI</b>	w.
Signature:	Date:

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Signature:	Date:	
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Signature:	Date:	
(4) Legal Name of Inventor: <b>Juntao LI</b>		
Signature:	Date:	9/23/2019

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RECORDED: 09/23/2019